L Number	Hits	Search Text	DB	Time stamp
-	188963	interconnection	USPAT;	2003/10/02
	200000		US-PGPUB;	07:28
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	52554	conductive same polymer	USPAT;	2003/10/01
			US-PGPUB;	15:37
			EPO; JPO;	
	,		DERWENT;	
	,		IBM_TDB	
-	6307	(solder or solderable) same (preform or	USPAT;	2003/10/01
		cap)	US-PGPUB;	15:27
			EPO; JPO;	
	•		DERWENT;	
			IBM_TDB	
-	281564	(electric or electrical) near7 connection	USPAT;	2003/10/01
			US-PGPUB;	15:27
.			EPO; JPO;	
		·	DERWENT; IBM TDB	
1_	124	interconnection and (conductive same	USPAT;	2003/10/01
	174	polymer) and ((solder or solderable) same	US-PGPUB;	15:28
		(preform or cap)) and ((electric or	EPO; JPO;	13.20
		electrical) near7 connection)	DERWENT;	
			IBM TDB	
_ '	22689	conductive near2 adhesive	USPAT;	2003/10/01
	22000		US-PGPUB;	15:37
		·	EPO; JPO;	•
		•	DERWENT;	
			IBM TDB	
-	693	interconnection same (conductive near2	USPAT;	2003/10/01
		adhesive)	US-PGPUB;	15:37
			EPO; JPO;	
			DERWENT;	
•			IBM_TDB	
-	180508	solder or solderable	USPAT;	2003/10/01
			US-PGPUB;	15:37
			EPO; JPO;	
		·	DERWENT;	
_	450	(interconnection same (conductive near2	IBM_TDB USPAT;	2002/10/01
_	430	adhesive)) and (solder or solderable)	US-PGPUB;	2003/10/01 15:37
	•	dancerve, and (sorder or sorderable)	EPO; JPO;	13.37
			DERWENT;	
			IBM TDB	
-	16773	(solder or solderable) near2 ball	USPAT;	2003/10/01
	_	"	US-PGPUB;	15:38
			EPO; JPO;	
			DERWENT;	
		· ·	IBM_TDB	
-	139	((interconnection same (conductive near2	USPAT;	2003/10/01
		adhesive)) and (solder or solderable))	US-PGPUB;	15:38
		and ((solder or solderable) near2 ball)	EPO; JPO;	
			DERWENT;	
	0.00		IBM_TDB	2002/10/02
-	969	resin near ball	USPAT;	2003/10/02
			US-PGPUB;	07:28
			EPO; JPO;	
			DERWENT; IBM TDB	
_	87	(resin near ball) and solder	USPAT;	2003/10/02
	0 /	(restinguest part) and sorder	US-PGPUB;	07:34
			EPO; JPO;	
			DERWENT;	
			·IBM TDB	.
				L

		•	_	
-	700	solder near2 cap	USPAT;	2003/10/02
	1	_	US-PGPUB;	07:38
			EPO; JPO;	
			DERWENT;	
	1	,	IBM TDB	
	151	/golder rear? gam) and adherive	_	2003/10/02
-	121	(solder near2 cap) and adhesive	USPAT;	
			US-PGPUB;	07:34
	ļ		EPO; JPO;	
			DERWENT;	
		,	IBM TDB	
-	16808	solder near2 ball	USPAT;	2003/10/02
			US-PGPUB;	07:38
	<u> </u>	·	EPO; JPO;]
1.	į		DERWENT;	
		'		
		(14	IBM_TDB	0000110100
-	2212	(solder near2 ball) same adhesive	USPAT;	2003/10/02
			US-PGPUB;	07:39
			EPO; JPO;	l i
			DERWENT;	
i			IBM TDB	
_	28	((solder near2 ball) same adhesive) same	USPAT;	2003/10/02
		preform	US-PGPUB;	07:40
		Protorm		07.40
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	161	((solder near2 ball) same adhesive) same	USPAT;	2003/10/02
		interconnection	US-PGPUB;	07:45
			EPO; JPO;	
		· ·	DERWENT;	
			1	
			IBM_TDB	
-	11	(ball near2 solder near2 adhesive) same	USPAT;	2003/10/02
		(preform or interconnection)	US-PGPUB;	08:14
Ì			EPO; JPO;	1
		·	DERWENT;	
		·	IBM TDB	
_	45828	conductive near (polymer or resin or	USPAT;	2003/10/02
	10020	adhesive)	US-PGPUB;	08:14
		adirestive	1	00.14
			EPO; JPO;	1
	,		DERWENT;	
			IBM_TDB	
-	18833	flip near chip	USPAT;	2003/10/02
			US-PGPUB;	08:18
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	2219	(flip near chip) same interconnection		2003/10/03
	2219	(TITE HEAT CHIE) Same Interconnection	USPAT;	2003/10/02
			US-PGPUB;	08:18
			EPO; JPO;	
		'	DERWENT;	
			IBM TDB	
_	4687	(conductive near (polymer or resin or	USPAT;	2003/10/02
		adhesive)) same solder	US-PGPUB;	08:18
			EPO; JPO;	
			DERWENT;	
	25.0	//614	IBM_TDB	1 0000 (00 (00
-	350	((flip near chip) same interconnection)	USPAT;	2003/10/02
		and ((conductive near (polymer or resin	US-PGPUB;	08:23
		or adhesive)) same solder)	EPO; JPO;	
			DERWENT;	
			IBM TDB	
l - .	2	("5925930").PN.	USPAT;	2003/10/02
		\ JJEJJJU .FN		2003/10/02
			US-PGPUB;	08:23
			EPO; JPO;	<u> </u>
		·	DERWENT;	
	1		IBM TDB	1

		<u>, , , , , , , , , , , , , , , , , , , </u>		
-	28	("3320658" "3396894" "3472365"	USPAT	2003/10/02
		"3516155" "3719981" "3744129"		09:31
	!	"3795884" "3926360" "3982320"		
	1	"3991463" "3998512" "4027936"		
		"4064623" "4067104" "4089575"		
		"4144648" "4195193" "4209893"		
		"4216350" "4295700" "4334727"		
		"4354629" "4390220" "4402450"		
		"4412642" "4445736" "4458968"		
•		"4556276").PN.		
_	24	4712721.URPN.	USPAT	2003/10/02
	1			09:32
_	12	("5136365" "5187020" "5375042"	USPAT	2003/10/02
		"5412539" "5509200" "5518674"		09:34
		"5805426" "5893765" "5905638"		
		"5910641" "6090633" "6326561").PN.		
_	0	6600224.URPN.	USPAT	2003/10/02
				09:35
_	1	"3002481".PN.	USPAT	2003/10/02
				09:36
_	20	3744129.URPN.	USPAT	2003/10/02
				09:37
l -	14	("3472365" "4209893" "4216350"	USPAT	2003/10/02
		"4437232" "4712721" "4842184"		09:37
		"4903889" "5029748" "5323947"		
		"5363277" "5373984" "5388327"		
		"5438223" "5497938").PN.		
L		1		